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#### **Silicon NPN Power Transistor**

# **BD245/A/B/C**



TO-3P Plastic Leaded Package RoHS compliant

#### **DESCRIPTION**

- 1. Collector Current -I<sub>C</sub>= 10A
- 2. Collector-Emitter Breakdown Voltage:-  $V_{(BR)CEO}$  = 45V(Min)- BD245; 60V(Min)- BD245A 80V(Min)- BD245B; 100V(Min)- BD245C
- 3. Complement to Type BD246/A/B/C

### **APPLICATIONS:**

Designed for use in general purpose power amplifier and switching applications

# ABSOLUTE MAXIMUM RATINGS ( $T_a = 25 \text{ }_{\circ}\text{C}$ )

DESCRIPTION	SYMBOL	VALUES	UNIT
Collector Emitter Voltage	$V_{\scriptscriptstyle{\sf CEO}}$	100	V
Collector Base Voltage	$V_{\scriptscriptstyle \sf CBO}$	100	V
Emitter Base Voltage	V <sub>EBO</sub> 5		V
Collector Current Continuous	Ic	5	Α
Collector Current Peak	I <sub>CM</sub>	8	Α
Base Current	I <sub>B</sub>	120	mA
Power Dissipation upto T <sub>c</sub> =25°C	P₀	65	W
Derate above 25°C	<b>F</b> <sub>D</sub>	0.52	W/°C
Power Dissipation upto T <sub>a</sub> =25°C	P <sub>□</sub>	2	W
Derate above 25°C	Γ <sub>D</sub>	16	mW/°C
Unclamped Inductive Load Energy	*E	50	mJ
Operating And Storage Junction	т. т.	- 65 to +150	°C
Temperature	Tj, Tstg	- 03 10 + 130	

<sup>\*</sup>  $I_c$ =1A, L=100mH, P.R.F.=10Hz,  $V_{cc}$ =20V,  $R_{BE}$ =100Q





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# THERMAL RESISTANCE

DESCRIPTION	SYMBOL	VALUES	UNIT	
Junction to Case	$R_{\theta  \text{(j-c)}}$	1.92	°C/W	
Junction to Ambient in free air	$R_{\theta  (j-a)}$	62.5	30/00	

# ELECTRICAL CHARACTERISTICS at $T_a = 25 \, {}_{\circ}\text{C}$

DESCRIPTION	CVMPOL	SYMBOL TEST CONDITIONS		UES	UNIT
DESCRIPTION	STIVIBUL	1E31 CONDITIONS	MIN	MAX	UNII
Collector Emitter (sus) Voltage	*VCEO(sus)	I <sub>c</sub> =100mA, I <sub>в</sub> =0	100		V
		$V_{CE}$ =50V, $I_{B}$ =0			
Collector Cut Off Current	ICEO	V <sub>CE</sub> =40V, I <sub>B</sub> =0		0.5	
		$V_{CE}$ =30V, $I_{B}$ =0			
		V <sub>CB</sub> =100V, I <sub>E</sub> =0			mA
Collector Cut Off Current	Ісво	V <sub>CB</sub> =80V, I <sub>E</sub> =0		0.2	
		V <sub>CB</sub> =60V, I <sub>E</sub> =0			
Emitter Cut Off Current	<b>І</b> ЕВО	V <sub>EB</sub> =5V, I <sub>C</sub> =0		2	
DC Current Gain	*hfe	I <sub>C</sub> =3A, V <sub>CE</sub> =3V	6000		
Collector Emitter Saturation	*\/	$I_c=3A$ , $I_B=12mA$		2	
Voltage	*VCE (sat)	I <sub>c</sub> =5A, I <sub>B</sub> =20mA		4	V
Base Emitter On Voltage	*VBE (on)	I <sub>c</sub> =3A,V <sub>cE</sub> =3V		2.5	

Note:

\*Pulse Test : Pulse width  $\leq$ 300/-s, Duty Cycle  $\leq$ 2%

### **DYNAMIC CHARACTERISTIC**

DESCRIPTION	CVMDOL	TEST CONDITIONS		UES	LINUT
DESCRIPTION	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Small Signal Current Gain	h <sub>fe</sub>	$I_c=3A,V_{ce}=4V, f=1MHz$	4		
Output Capacitance	Cob	V <sub>cB</sub> =10V, I <sub>E</sub> =0, f=0.1MHz		200	pF

### **SWITCHING CHARACTERISTICS**

DESCRIPTION	SYMBOL TEST CONDITIONS VALUES		NDITIONS VALUES	
DESCRIPTION	STIMBOL	TEST CONDITIONS	Тур.	UNIT
Turn on time	ton	I <sub>c</sub> =3A, R <sub>∟</sub> =10	0.4	S
Turn off time	toff	I <sub>B1</sub> =I <sub>B2</sub> =12mA I <sub>B1</sub> =I <sub>B2</sub> =12mA	1.2	S

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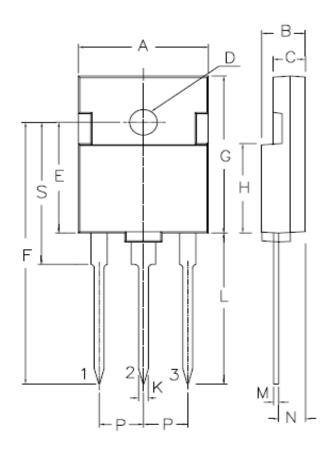




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# **Package Details**

# **TO-3P Package Outline and Dimension**



DIM	MIN.	MAX.
Α	15.8	16.4
В	5.2	5.7
С	3.8	4.2
D	ø3.3	ø3.6
Ε	14.50	15.10
F	33.25	36.75
G	20.75	21.25
Н	11.50	12.25
K	1.0	1.30
L	18.75	21.65
М	0.40	0.60
Ν	3.15	3.45
Р	5.21	5.72
S	18.75	19.25

# PIN CONFIGURATION

- BASE
- 2. COLLECTOR
- 3. EMITTER





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# Recommended Product Storage Environment for Diode and Transistors

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- Humidity between 40 to 70 %RH
- Air should be clean.
- Avoid harmful gas or dust.
- Avoid outdoor exposure or storage in areas subject to rain or water spraying.
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- Avoid rapid change of temperature.
- Avoid condensation.
- Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

#### Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years, the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

#### Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start. For this the following JEDEC table may be referred:

JEDEC MSL Level				
Level	Time	Condition		
1	Unlimited	<30 °C / 85% RH		
2	1 Year	<30 °C / 60% RH		
2a	4 Weeks	≤30 °C / 60% RH		
3	168 Hours	≤30 °C / 60% RH		
4	72 Hours	≤30 °C / 60% RH		
5	48 Hours	≤30 °C / 60% RH		
5a	24 Hours	≤30 °C / 60% RH		
6	Time on Label(TOL)	<30 °C / 60% RH		

Figure 1 Floor Life according to JEDEC MSL Level

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#### **Customer Notes**

#### **Component Disposal Instructions**

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

#### **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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